

# SN74LV4052A-EP

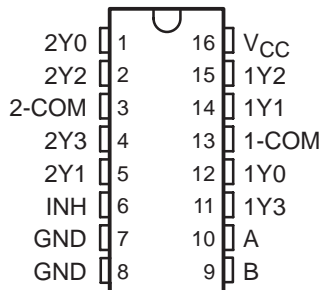
## DUAL 4-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

SCLS502C – MAY 2003 – REVISED MAY 2004

- **Controlled Baseline**
  - One Assembly/Test Site, One Fabrication Site
- **Extended Temperature Performance of –40°C to 105°C**
- **Enhanced Diminishing Manufacturing Sources (DMS) Support**
- **Enhanced Product-Change Notification**
- **Qualification Pedigree†**
- **Supports Mixed-Mode Voltage Operation on All Ports**
- **Fast Switching**
- **High On-Off Output-Voltage Ratio**
- **Low Crosstalk Between Switches**
- **Extremely Low Input Current**
- **ESD Protection Exceeds JESD 22**
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)

† Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

**D OR PW PACKAGE  
(TOP VIEW)**



### description/ordering information

This dual 4-channel CMOS analog multiplexer/demultiplexer is designed for 2-V to 5.5-V  $V_{CC}$  operation.

The SN74LV4052A handles both analog and digital signals. Each channel permits signals with amplitudes up to 5.5 V (peak) to be transmitted in either direction.

Applications include signal gating, chopping, modulation or demodulation (modem), and signal multiplexing for analog-to-digital and digital-to-analog conversion systems.

### ORDERING INFORMATION

$T_A$	PACKAGE‡		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 105°C	SOIC – D	Tape and reel	SN74LV4052ATDREP	LV4052ATEP
	TSSOP – PW	Tape and reel	SN74LV4052ATPWREP	L4052EP

‡ Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

**FUNCTION TABLE**

INPUTS			ON CHANNEL
INH	B	A	
L	L	L	1Y0, 2Y0
L	L	H	1Y1, 2Y1
L	H	L	1Y2, 2Y2
L	H	H	1Y3, 2Y3
H	X	X	None



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**PRODUCTION DATA** information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

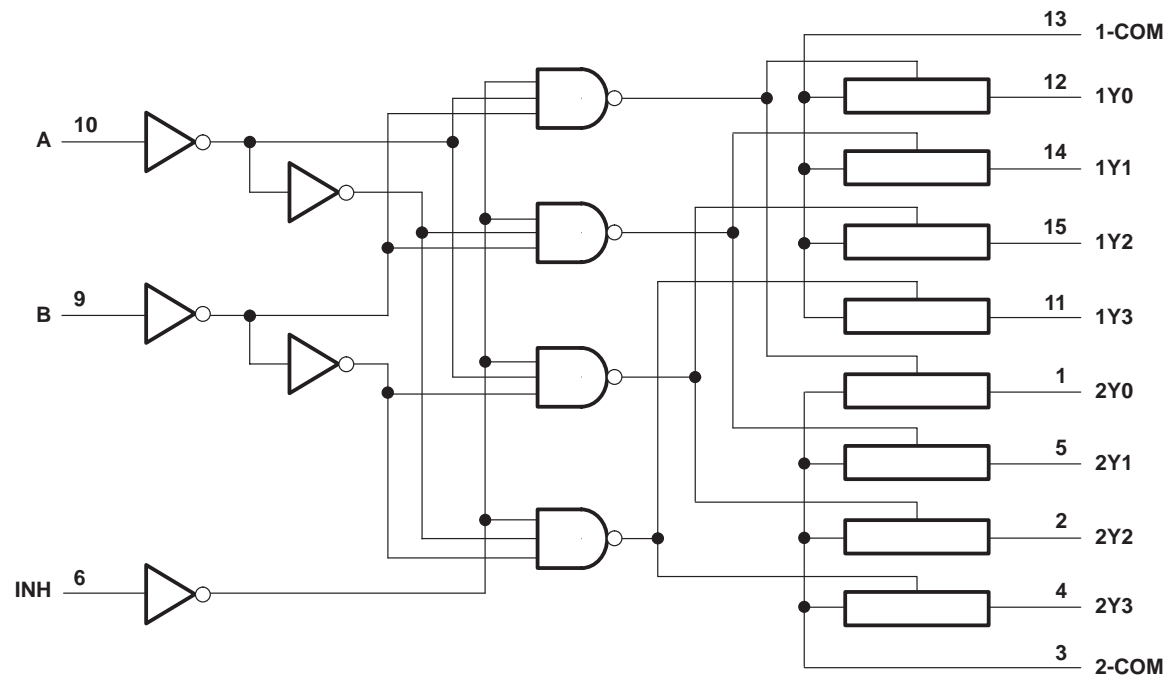
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SN74LV4052A-EP  
DUAL 4-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$	–0.5 V to 7.0 V
Input voltage range, $V_I$ (see Note 1)	–0.5 V to 7.0 V
Switch I/O voltage range, $V_{IO}$ (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	–20 mA
I/O diode current, $I_{IOK}$ ( $V_{IO} < 0$ )	–50 mA
Switch through current, $I_T$ ( $V_{IO} = 0$ to $V_{CC}$ )	±25 mA
Continuous current through $V_{CC}$ or GND	±50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): D package	73°C/W
PW package	108°C/W
Storage temperature range, $T_{stg}$	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.  
2. This value is limited to 5.5 V maximum.  
3. The package thermal impedance is calculated in accordance with JESD 51-7.

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## DUAL 4-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

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### recommended operating conditions (see Note 4)

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage		2 <sup>†</sup>	5.5	V
V <sub>IH</sub>	High-level input voltage, control inputs	V <sub>CC</sub> = 2 V	1.5		V
		V <sub>CC</sub> = 2.3 V to 2.7 V	V <sub>CC</sub> × 0.7		
		V <sub>CC</sub> = 3 V to 3.6 V	V <sub>CC</sub> × 0.7		
		V <sub>CC</sub> = 4.5 V to 5.5 V	V <sub>CC</sub> × 0.7		
V <sub>IL</sub>	Low-level input voltage, control inputs	V <sub>CC</sub> = 2 V		0.5	V
		V <sub>CC</sub> = 2.3 V to 2.7 V		V <sub>CC</sub> × 0.3	
		V <sub>CC</sub> = 3 V to 3.6 V		V <sub>CC</sub> × 0.3	
		V <sub>CC</sub> = 4.5 V to 5.5 V		V <sub>CC</sub> × 0.3	
V <sub>I</sub>	Control input voltage		0	5.5	V
V <sub>IO</sub>	Input/output voltage		0	V <sub>CC</sub>	V
Δt/Δv	Input transition rise or fall rate	V <sub>CC</sub> = 2.3 V to 2.7 V		200	ns/V
		V <sub>CC</sub> = 3 V to 3.6 V		100	
		V <sub>CC</sub> = 4.5 V to 5.5 V		20	
T <sub>A</sub>	Operating free-air temperature		–40	105	°C

<sup>†</sup> With supply voltages at or near 2 V, the analog switch on-state resistance becomes very nonlinear. It is recommended that only digital signals be transmitted at these low supply voltages.

NOTE 4: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V <sub>CC</sub>	MIN	MAX	UNIT
r <sub>on</sub>	On-state switch resistance I <sub>T</sub> = 2 mA, V <sub>I</sub> = V <sub>CC</sub> or GND, V <sub>INH</sub> = V <sub>IL</sub> , (see Figure 1)	2.3 V		225	Ω
		3 V		190	
		4.5 V		100	
r <sub>on(p)</sub>	Peak on-state resistance I <sub>T</sub> = 2 mA, V <sub>I</sub> = V <sub>CC</sub> to GND, V <sub>INH</sub> = V <sub>IL</sub>	2.3 V		600	Ω
		3 V		225	
		4.5 V		125	
Δr <sub>on</sub>	Difference in on-state resistance between switches I <sub>T</sub> = 2 mA, V <sub>I</sub> = V <sub>CC</sub> to GND, V <sub>INH</sub> = V <sub>IL</sub>	2.3 V		40	Ω
		3 V		30	
		4.5 V		20	
I <sub>I</sub>	Control input current V <sub>I</sub> = 5.5 V or GND	0 to 5.5 V		±1	μA
I <sub>S(off)</sub>	Off-state switch leakage current V <sub>I</sub> = V <sub>CC</sub> and V <sub>O</sub> = GND, or V <sub>I</sub> = GND and V <sub>O</sub> = V <sub>CC</sub> , V <sub>INH</sub> = V <sub>IH</sub> , (see Figure 2)	5.5 V		±1	μA
I <sub>S(on)</sub>	On-state switch leakage current V <sub>I</sub> = V <sub>CC</sub> or GND, V <sub>INH</sub> = V <sub>IL</sub> , (see Figure 3)	5.5 V		±1	μA
I <sub>CC</sub>	Supply current V <sub>I</sub> = V <sub>CC</sub> or GND	5.5 V		20	μA



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## DUAL 4-CHANNEL ANALOG MULTIPLEXER/DEMULTIPLEXER

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**switching characteristics over recommended operating free-air temperature range,  
V<sub>CC</sub> = 3.3 V ± 0.3 V (unless otherwise noted)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	MAX	UNIT
t <sub>PLH</sub> t <sub>PHL</sub> Propagation delay time	COM or Y	Y or COM	C <sub>L</sub> = 50 pF, (see Figure 4)		12	ns
t <sub>PZH</sub> t <sub>PZL</sub> Enable delay time	INH	COM or Y	C <sub>L</sub> = 50 pF, (see Figure 5)		25	ns
t <sub>PHZ</sub> t <sub>PLZ</sub> Disable delay time	INH	COM or Y	C <sub>L</sub> = 50 pF, (see Figure 5)		25	ns

**switching characteristics over recommended operating free-air temperature range,  
V<sub>CC</sub> = 5 V ± 0.5 V (unless otherwise noted)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	MAX	UNIT
t <sub>PLH</sub> t <sub>PHL</sub> Propagation delay time	COM or Y	Y or COM	C <sub>L</sub> = 50 pF, (see Figure 4)		8	ns
t <sub>PZH</sub> t <sub>PZL</sub> Enable delay time	INH	COM or Y	C <sub>L</sub> = 50 pF, (see Figure 5)		18	ns
t <sub>PHZ</sub> t <sub>PLZ</sub> Disable delay time	INH	COM or Y	C <sub>L</sub> = 50 pF, (see Figure 5)		18	ns

**analog switch characteristics over recommended operating free-air temperature range (unless  
otherwise noted)**

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V <sub>CC</sub>	T <sub>A</sub> = 25°C			UNIT
					MIN	TYP	MAX	
Frequency response (switch on)	COM or Y	Y or COM	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 600 Ω, f <sub>in</sub> = 1 MHz (sine wave) (see Note 5 and Figure 6)	2.3 V		30		MHz
				3 V		35		
				4.5 V		50		
Crosstalk (between any switches)	COM or Y	Y or COM	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 600 Ω, f <sub>in</sub> = 1 MHz (sine wave) (see Note 6 and Figure 7)	2.3 V		–45		dB
				3 V		–45		
				4.5 V		–45		
Crosstalk (control input to signal output)	INH	COM or Y	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 600 Ω, f <sub>in</sub> = 1 MHz (square wave) (see Figure 8)	2.3 V		20		mV
				3 V		35		
				4.5 V		65		
Feedthrough attenuation (switch off)	COM or Y	Y or COM	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 600 Ω, f <sub>in</sub> = 1 MHz (sine wave) (see Note 6 and Figure 9)	2.3 V		–45		dB
				3 V		–45		
				4.5 V		–45		
Sine-wave distortion	COM or Y	Y or COM	C <sub>L</sub> = 50 pF, R <sub>L</sub> = 10 kΩ, f <sub>in</sub> = 1 kHz (sine wave) (see Figure 10)	V <sub>I</sub> = 2 V <sub>p-p</sub>	2.3 V		0.1	%
				V <sub>I</sub> = 2.5 V <sub>p-p</sub>	3 V		0.1	
				V <sub>I</sub> = 4 V <sub>p-p</sub>	4.5 V		0.1	

NOTES: 5. Adjust f<sub>in</sub> voltage to obtain 0 dBm at output. Increase f<sub>in</sub> frequency until dB meter reads –3 dB.

6. Adjust f<sub>in</sub> voltage to obtain 0 dBm at input.



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operating characteristics,  $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
$C_{pd}$ Power dissipation capacitance	$C_L = 50\text{ pF}$ , $f = 10\text{ MHz}$	11.8	pF

### PARAMETER MEASUREMENT INFORMATION

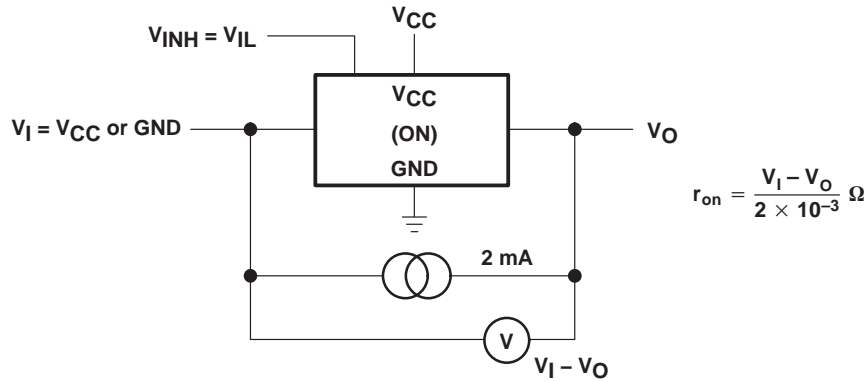


Figure 1. On-State Resistance Test Circuit

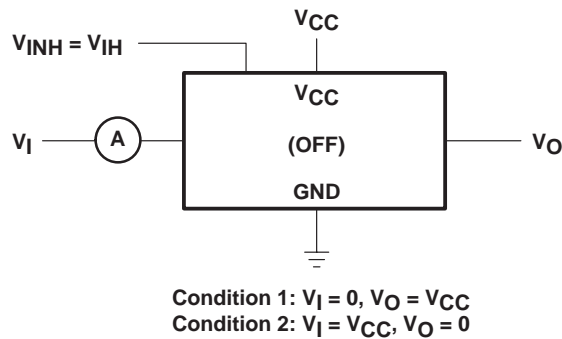


Figure 2. Off-State Switch Leakage-Current Test Circuit

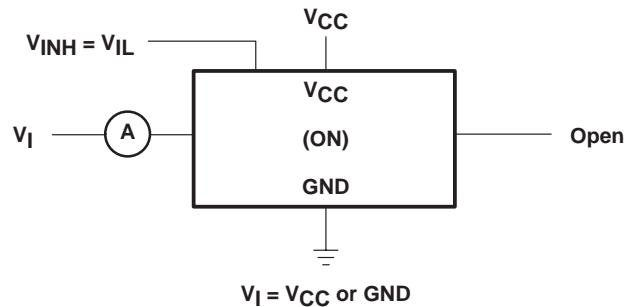


Figure 3. On-State Switch Leakage-Current Test Circuit

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## PARAMETER MEASUREMENT INFORMATION

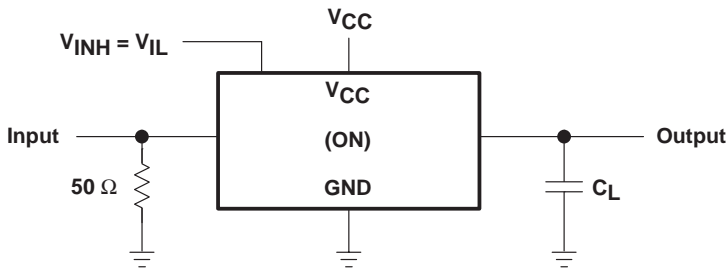


Figure 4. Propagation Delay Time, Signal Input to Signal Output

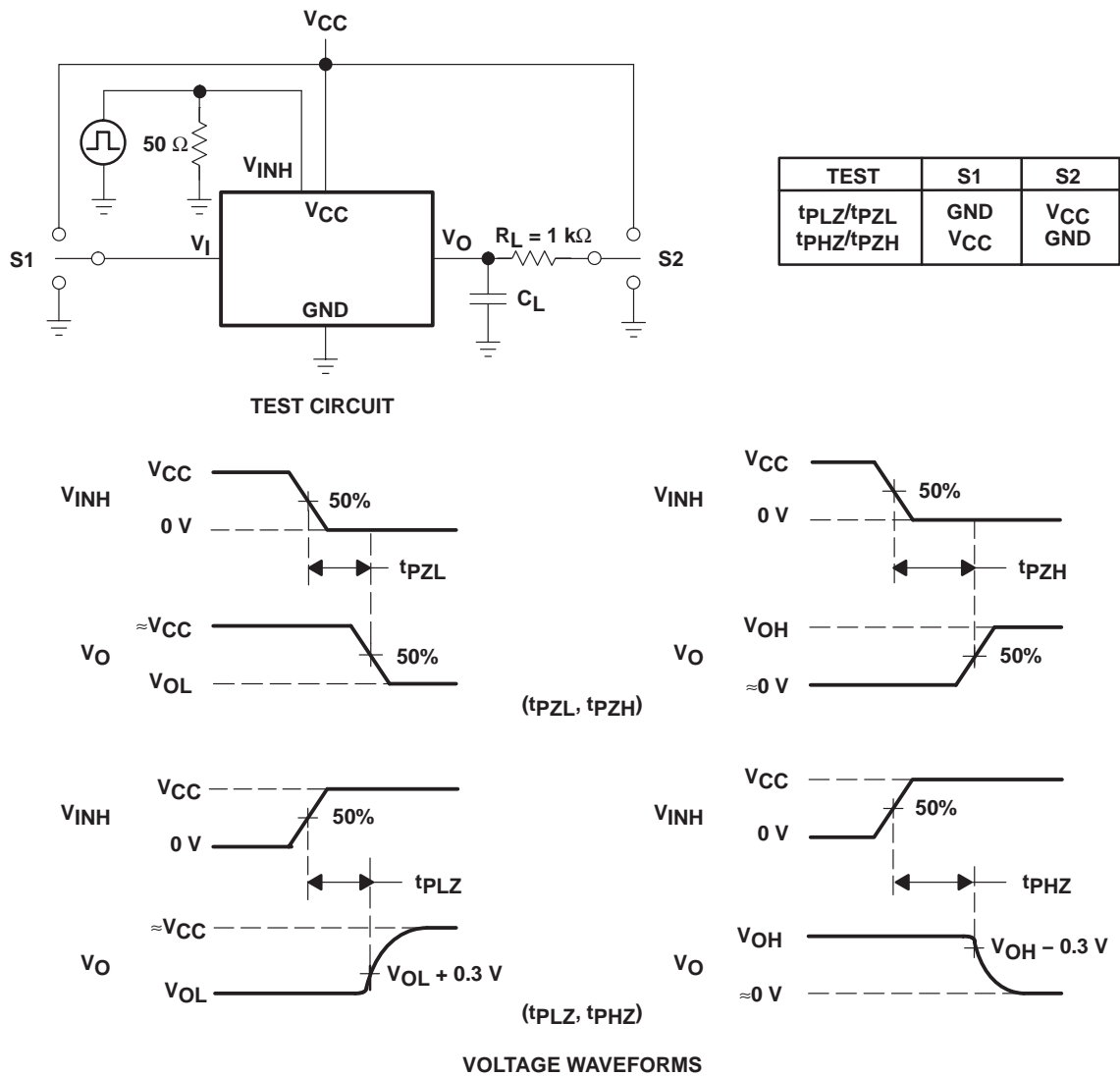
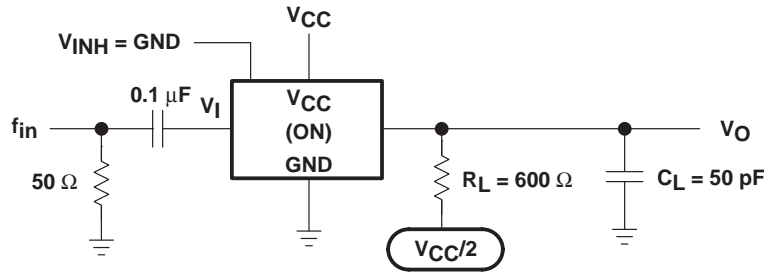
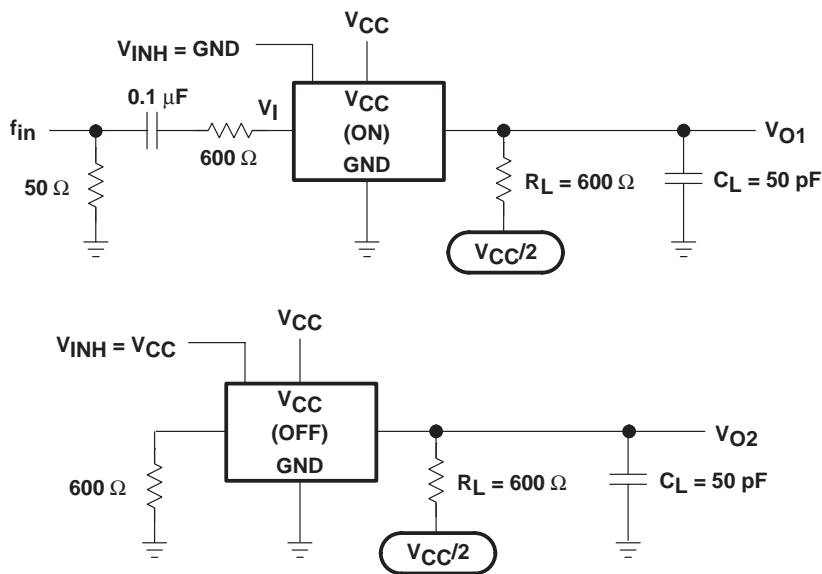


Figure 5. Switching Time (tPZL, tPLZ, tPZH, tPHZ), Control to Signal Output

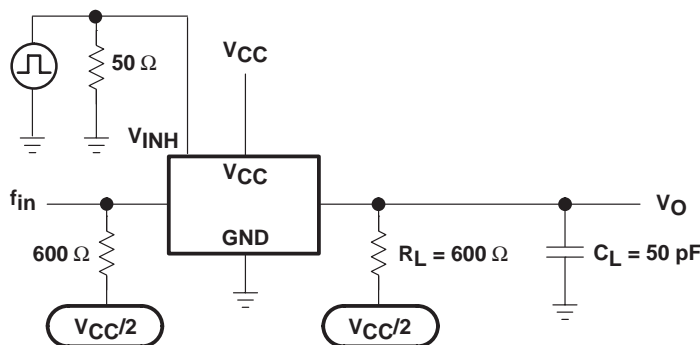
### PARAMETER MEASUREMENT INFORMATION



**Figure 6. Frequency Response (Switch On)**



**Figure 7. Crosstalk Between Any Two Switches**



**Figure 8. Crosstalk Between Control Input and Switch Output**

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### PARAMETER MEASUREMENT INFORMATION

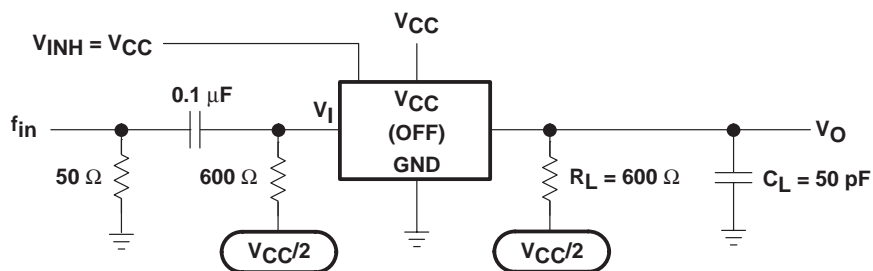


Figure 9. Feedthrough Attenuation (Switch Off)

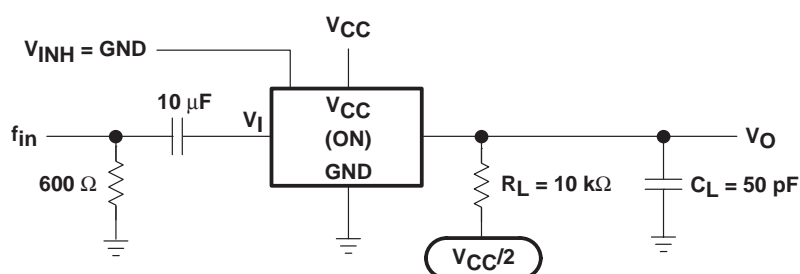


Figure 10. Sine-Wave Distortion



## PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">SN74LV4052ATPWREP</a>	Active	Production	TSSOP (PW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	L4052EP
SN74LV4052ATPWREP.A	Active	Production	TSSOP (PW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	L4052EP
<a href="#">V62/03665-01XE</a>	Active	Production	TSSOP (PW)   16	2000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 105	L4052EP

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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### OTHER QUALIFIED VERSIONS OF SN74LV4052A-EP :

- Catalog : [SN74LV4052A](#)

- Automotive : [SN74LV4052A-Q1](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

## TAPE AND REEL INFORMATION



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LV4052ATPWREP	TSSOP	PW	16	2000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LV4052ATPWREP	TSSOP	PW	16	2000	353.0	353.0	32.0



## PACKAGE OUTLINE

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



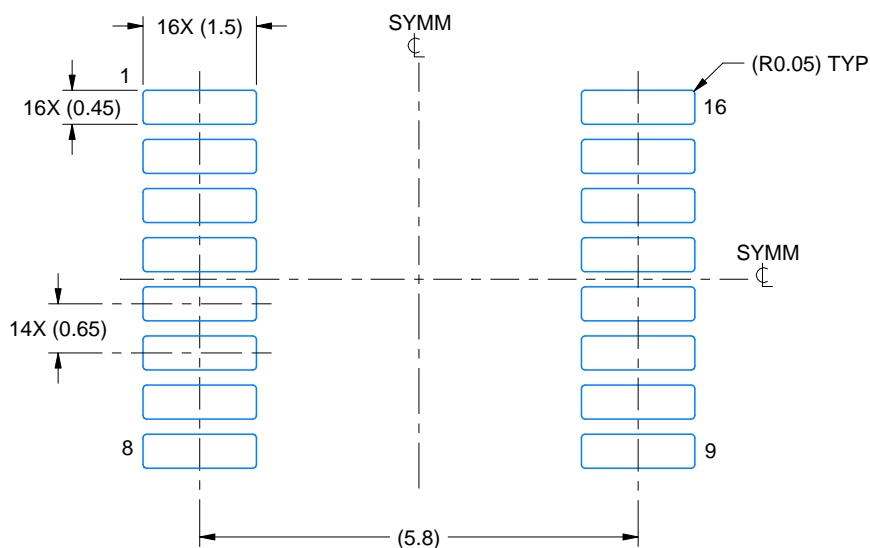
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
5. Reference JEDEC registration MO-153.

# EXAMPLE BOARD LAYOUT

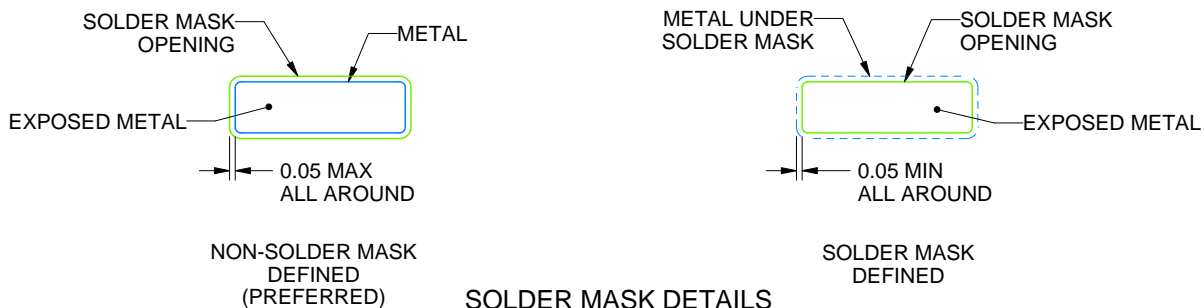
PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE: 10X



SOLDER MASK DETAILS

4220204/B 12/2023

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

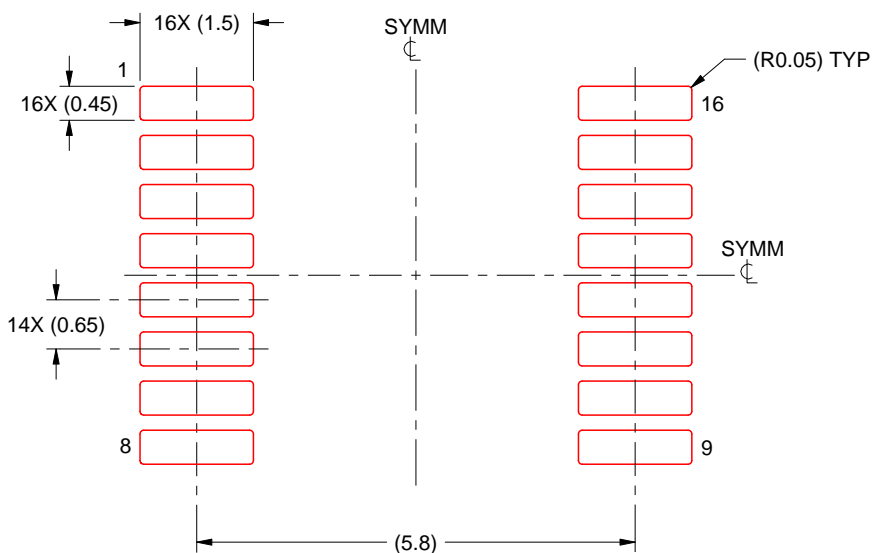
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

PW0016A

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE: 10X

4220204/B 12/2023

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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